SDLS007

D2635, JANUARY 1981-REVISED MARCH 1988

- 8-Bit Parallel Storage Register Inputs ('LS597)
- Parallel 3-State I/O, Storage Register Inputs, Shift Register Outputs ('LS598)
- Shift Register has Direct Overriding Load and Clear
- Accurate Shift-Frequency . . . DC to 20 MHz

description

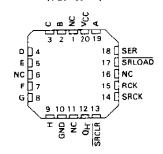
The 'LS597 comes in a 16-pin package and consists of an 8-bit storage latch feeding a parallel-in, serial-out 8-bit shift register. Both the storage register and shift register have positive-edge triggered clocks. The shift register also has direct load (from storage) and clear inputs.

The 'LS598 comes in a 20-pin package and has all the features of the 'LS597 plus 3-state I/O ports that provide parallel shift register outputs and also has multiplexed serial data inputs.

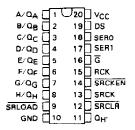
SN54LS597 . . . J OR W PACKAGE SN74LS597 . . . N PACKAGE (TOP VIEW)



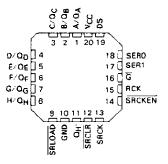
SN54LS597 . . . FK PACKAGE (TOP VIEW)



SN54LS598 . . . J OR W PACKAGE LS598 . . . DW OR N PACKAGE (TOP VIEW)

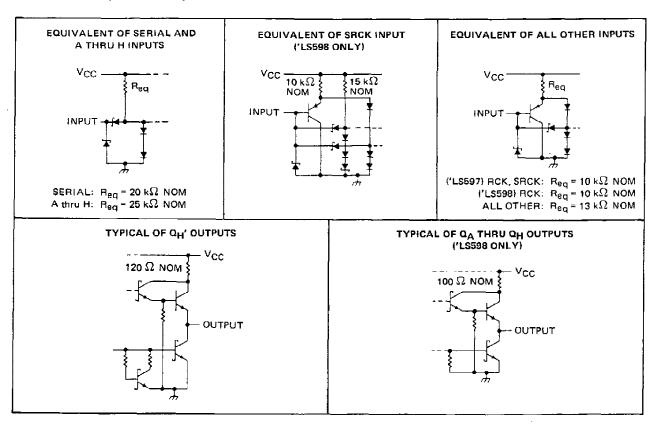


SN54LS598 . . . FK PACKAGE (TOP VIEW)

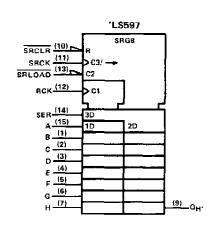


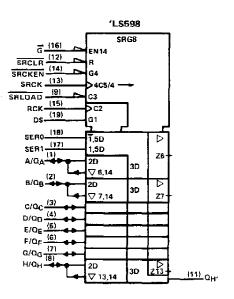
NC - No internal connection

schematics of inputs and outputs



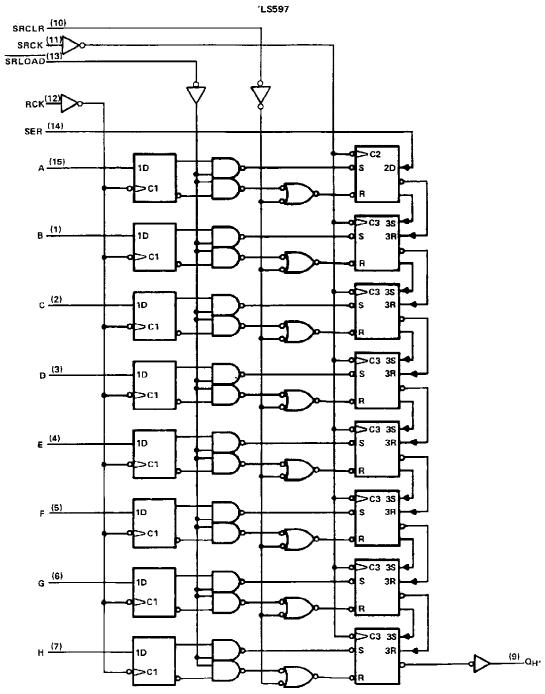
logic symbols†



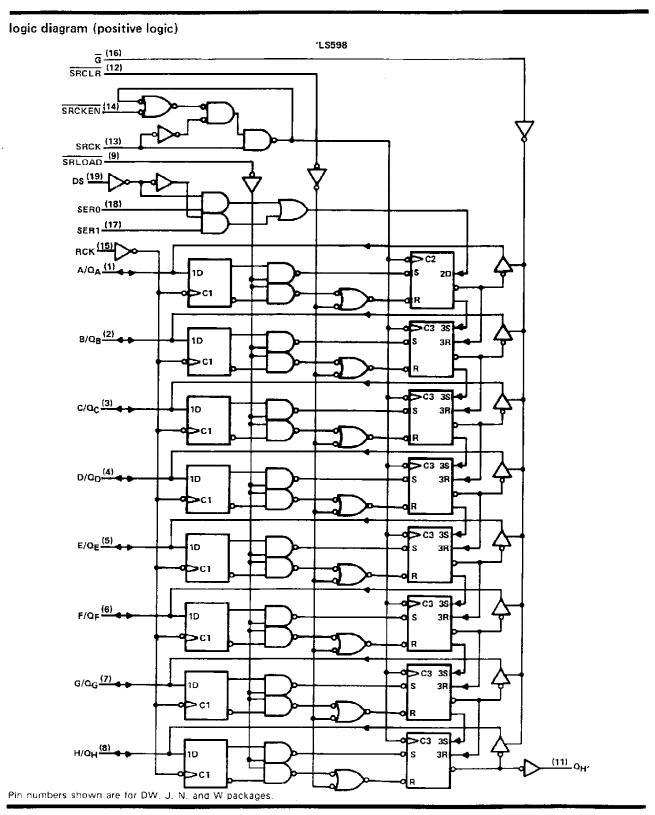


 $^{^\}dagger$ This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for DW, J, N, and W packages.

logic diagram (positive logic)



Pin numbers shown are for DW, J, N, and W packages.



NOTE 1: Voltage values are with respect to the network ground terminal,

recommended operating conditions

	·			•	' SN54LS'			SN74LS'			UNIT
					MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	Supply voltage				5	5.5	4.75	5	5.25	V
VIH	High-level input v	High-level input voltage						2			٧
VIL	Low-level input vi	oltage					0.7			0.8	V
юн	High-level output current		ΩH'	Q _H ' Q _A thru Q _H , 'LS598 only			- 1			– 1	mΑ
			Q _A thru Q ₁				- 1			- 2.6	1000
loL	Low-level output current		ΩH	: _H ' 8				16	16 mA		
			QA thru QH, 'L\$598 only				12			24	mA
fsck	Shift clock freque	псу	/				20	0		20	MHz
	Pulse duration		SRCK	hīgh	15			15			
				low	35			35			
t _w			RCK	RCK				20			ns
			SRCLR		20			20			
			SRLOAD		40			40			
		Data before F	Data before RCK † DS before SRCK † ('LS598 only) SRCKEN low before SRCK † ('LS598 only)		20			20			1
	Setup time	DS before SF			30			30			1
t _{su}		SRCK EN ION			20			20			
		SRCLR inact	SRCLR inactive before SRCK 1		25	-		25			⊓s
		SRLOAD ina	SRLOAD inactive before SRCK 1			•		30			ĺ
		RCK † before	RCK † before SRLOAD † (see Note 2)					40			
		SER before S	R before SRCK t		20			20			
th	Hold time							0			ns
TA	Operating free-air temperature				- 55	-	125	0		70	°C

NOTE 2: The RCK 1 before SRLOAD 1 setup time ensures the data saved by RCK 1 will also be loaded into the shift register.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST COMPLETIONS!		SN54LS'			SN74LS'			UNIT	
		TEST CONDITIONS [†]			MIN	TYP‡	MAX	MIN	TYP‡	MAX	ONIT
Vik		VCC = MIN,	I _I = - 18 mA	***			- 1.5			- 1.5	٧
∨он	T	V MIN	V _{IH} = 2 V,	I _{OH} = - 1 mA	2.4	3.2					٧
	'LS598 Q	ACC = INITIA'		I _{OH} = - 2.6 mA				2.4	3.1		
	α _H ′	VIL-WAX		i _{OH} = − 1 mA	2.4	3.2		2.4	3.2		
VOL	'LS598 Q	V _{CC} = MIN, V _{IL} = MAX		I _{OL} = 12 mA		0.25	0.4		0.25	0.4	٧
	C3396 G			IOL = 24 mA					0.35	0.5	
	ΩH,			IOL = 8 mA		0.25	0.4	ļ	0.25	0.4	
	ЧН			IOL = 16 mA				L	0.35	0.5	
^I OZH	'L\$598 Q	V _{CC} = MAX, V _O = 2.7 V	V _{IH} = 2 V,	V _{1L} = MAX,			20			20	μΑ
lozt	'LS598 Q	V _{CC} = MAX, V _O = 0.4 V	V _{IH} = 2 V,	VIL = MAX,			- 0.4			- 0.4	mA
	′LS598 Q	VCC = MAX		V ₁ = 5.5 V			0.1			0.1	mΑ
11	Others			V ₁ = 7 V			0.1			0.1	IIIA
ЧН		VCC = MAX.	V _I = 2.7 V				20			20	μA
	'L\$598 SRCK						- 0.8			- Q.8	
IIL.	SER, A Thru H	VCC = MAX,	V ₁ = 0.4 V				- 0.4			- 0.4	mA
	Others				į		- 0.2			- 0.2	<u> </u>
losŝ	'LS598 Q	V _{CC} = MAX,	Vo = 0 V		- 30		- 130	- 30		<u> </u>	m.A.
102%	ΩH'	ACC - MAY	•0 ••		- 20		- 100	- 20		<u> </u>	
	LS597 CCH		•		<u> </u>	35	53		35	53	
	lccr	V _{CC} = MAX,				35	53		35	53	
Icc	Іссн	All possible inc	outs grounded,			45	68		45	68	mΑ
	'LS598 ICCL	All outputs op	en			54	80		54	80	
	ccz					56	85		56	85	

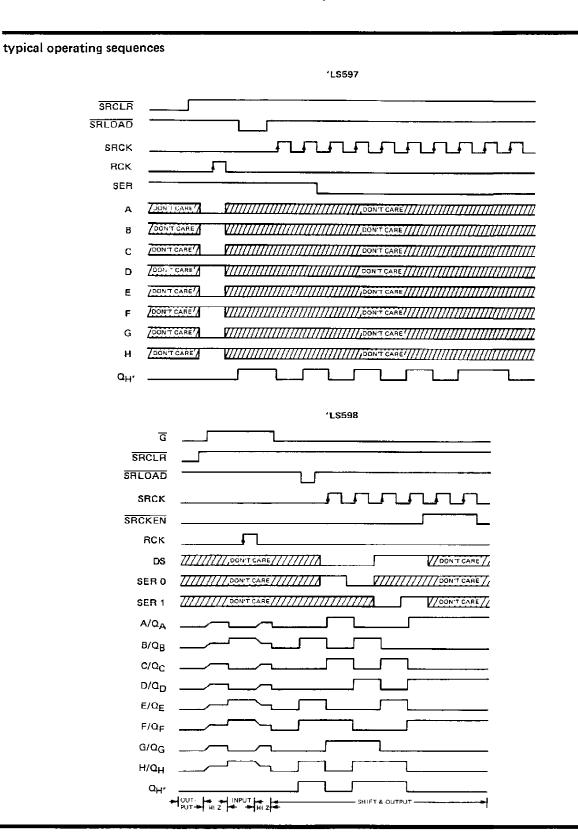
[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 $[\]ddagger$ All typical values are at VCC = 5 V, TA = 25°C §Not more than one output should be shorted at a time and the duration of the short-circuit should not exceed one second.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25 \,^{\circ}\text{C}$, (see note 3)

	FROM	то		1S597			'LS598				
PARAMETER	(INPUT)	(OUTPUT)	TEST CON	MIN	TYP	MAX	MiN	TYP	MAX	UNIT	
fmax	SRCK	a	$R_L = 667 \Omega$,	CL = 45 pF	20	35		20	35		MHz
f _{max}	SRCK	QH'	$R_L = 1 k\Omega$	C _L = 30 pF	20	35					MHz
tPLH	SRCK†	ΩH'	R _L = 1 kΩ,			15	23	l	11	17	ns
tPHL .	SPCK1	QH'		0 20 -5		20	30		15	23	กร
t _{PLH}	SRLOAD↓	ΩH,		C(= 30 pr		38	57		28	42	กร
^T PHL	SRLOAD↓	α _H '				29	44		20	30	ns
t _{PHL}	SRCLR	α _H '				24	36		18	27	ns
^t PLH	RCK1	α _H ′	$R_L = 1 \text{ k}\Omega.$	Ct = 30 pF		41	60		32	48	ns
[†] PHL	RCK1	αH.	SRLOAD = L			32	48	ĺ .	24	36	nş
[†] PLH	SRCKt	a	R _L = 667 Ω.		[-	12	18	ns
[†] PHL	SRCK1	α							19	28	ПБ
^t PLH	SRLOAD↓	α						32	48	ns	
[†] PHL	SRLOAD↓	α		C _L = 45 pF				24 36 12 18 19 28	40	пъ	
TPHL	SRCLR	Ω							25	38	ns
[†] PZH	G↓	a							26	31	ns
t PZL	G∔	Q							29	43	ns
tPHZ	Gt	Q	A _L = 667 Ω,						25	38	ns
tPLZ	Gt	Q		CL = 5 pr					20	30	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



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